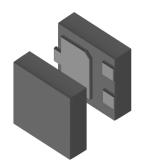


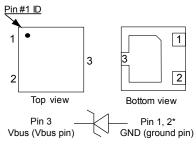


Datasheet

High power transient voltage suppressor



QFN package



*Pin 1 and Pin 2 must be connected together.

Product status link ESDA22P150-1U3M

Features

- Low clamping voltage
- Peak pulse power:
- 4500 W (8/20µs)
- Stand off voltage 20 V
- Unidirectional diode
- Low leakage current:
 - 0.25 µA at 25°C
 - Complies with the following standards: IEC 61000-4-2 level 4
 - ± 30 kV (air discharge)
 - ± 30 kV (contact discharge)

Application

Where transient over voltage protection in ESD sensitive equipment is required, such as:

- Smartphones, mobile phones, tablets, portable multimedia
- USB V_{bus} protection
- Power supply protection
- Battery protection

Description

•

The ESDA22P150-1U3M is a unidirectional single line TVS diode designed to protect the power line against EOS & ESD transients.

The device is ideal for applications where high power TVS and board space saving is required.

1 Characteristics

Symbol	Parameter		Value	Unit
V	V _{pp} Peak pulse voltage	IEC 61000-4-2 contact discharge	>30	kV
∙ рр		IEC 61000-4-2 air discharge	>30	
P _{pp}	Peak pulse power (8/20 µs)		4500	W
I _{pp}	Peak pulse current (8/20 µs)		150	А
P _{pp}	Peak pulse power (10/1000 µs)		330	W
I _{pp}	Peak pulse current (10/1000 μs)		11	А
T _{op}	Operating junction temperature range		-55 to 150	°C
T _{stg}	Storage junction temperature range		-55 to 150	°C

Table 1. Absolute maximum ratings (T_{amb} = 25 °C)

Figure 1. Electrical characteristics (definitions)

$\begin{array}{c} \text{Symbol} \\ V_{\text{BR}} \\ V_{\text{CL}} \\ I_{\text{RM}} \\ V_{\text{RM}} \\ I_{\text{PP}} \end{array}$	= = = =	Parameter Breakdown voltage Clamping voltage Leakage current @V _{RM} Stand-off voltage Peak pulse current	(CL V BR VRM ^I F	V _F
R _D I _R V _F I _F	= = =	Dynamic resistance Breakdown current Forward voltage Forward current	Slope = 1/ R _d	I _R

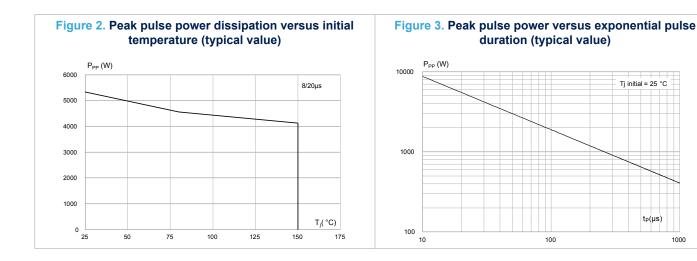
Table 2. Electrical characteristics (values) (T_{amb} = 25° C)

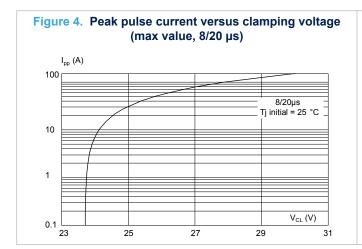
Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{RM}				20	V
V _{BR}	I _R = 1 mA	21	22	23.5	V
I _{RM}	V _{RM} = 20 V			250	nA
M	I _{PP} = 100 A 8/20µs		28	31	31 V 34 V
V _{CL}	I _{PP} = 150 A 8/20µs		31	34	
R _D	8/20µs		0.06		Ω
V _{CL}	I _{PP} = 9.2 A 10/1000 μs		27.5	30	V
R _D	10/1000 μs		0.5		Ω
V _F	I _F = 10 mA		0.7		V

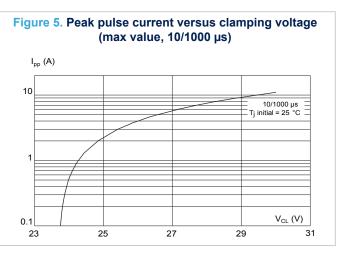
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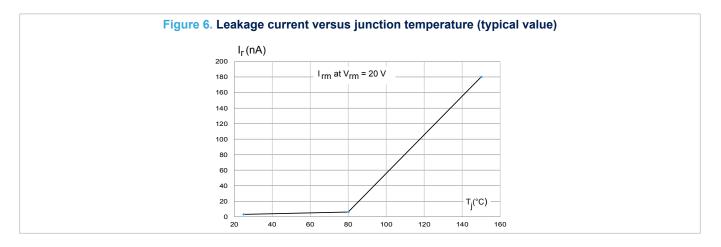
1.1 **Characteristics (curves)**

57

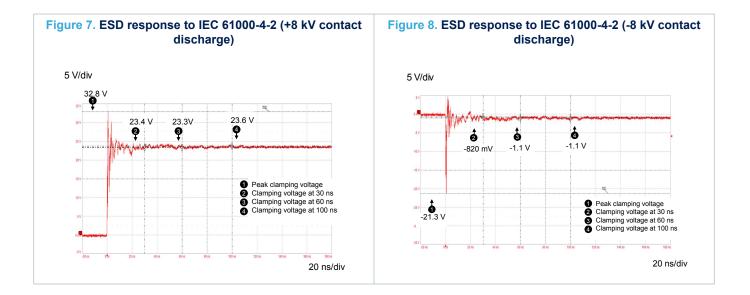














2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

2.1 QFN package information

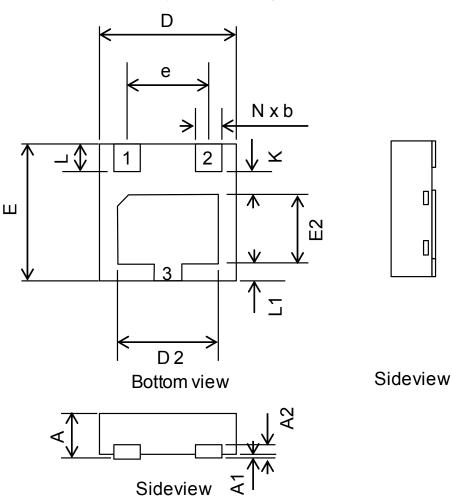


Figure 9. QFN package outline

	Dimensions				
Ref.	Millimeters				
	Min.	Тур.	Max.		
A	0.51	0.55	0.60		
A1	0.00	0.02	0.05		
A2		0.15			
b	0.25	0.30	0.35		
D		2.00			
E		2.00			
е		1.30			
D2	1.40	1.50	1.60		
E2	0.90	1.00	1.10		
К	0.20				
L1		0.25			
L	0.35	0.40	0.45		
Ν		3			

Table 3. QFN package mechanical data

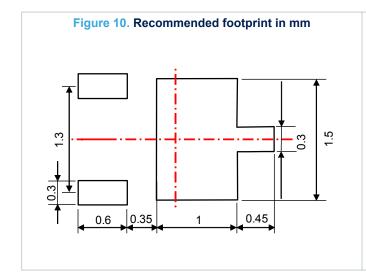
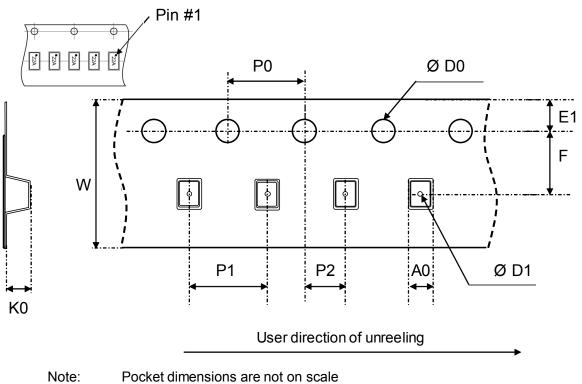




Figure 12. Tape outline



Pocket shape may vary depending on package

	Dimensions (milimeters) Millimeters			
Ref.				
	Min.	Тур.	Max.	
P1	3.90	4.00	4.10	
P0	3.90	4.00	4.10	
Ø D0	1.50	1.55	1.60	
Ø D1	1.00			
F	3.40	3.50	3.60	
E1	1.65	1.75	1.85	
К0	0.65	0.75	0.85	
P2	1.95	2.00	2.05	
W	7.70	8.00	8.30	
A0	2.15	2.25	2.35	

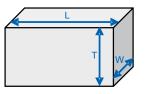
Table 4. Tape and reel dimensions

3 Recommendation on PCB assembly

3.1 Stencil opening design

- 1. General recommendation on stencil opening design
 - a. Stencil opening dimensions: L (Length), W (Width), T (Thickness).

Figure 13. Stencil opening recommendation



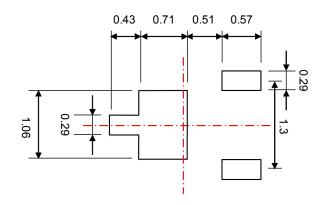
- b. General design rule
 - \circ Stencil thickness (T) = 75 ~ 125 μ m

$$\frac{W}{T} \ge 1.5$$

$$\frac{L \times W}{2T(L+W)} \ge 0.66$$

- 1. Reference design
 - a. Stencil opening thickness: 100 µm
 - b. Stencil opening for leads: Opening to footprint ratio is 90%
 - c. Stencil opening for expose pad: Opening to footprint ratio is 50%

Figure 14. Recommended stencil window position in mm



3.2 Solder paste

- 1. Halide-free flux qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste is recommended.
- 3. Offers a high tack force to resist component movement during high speed.
- 4. Use solder paste with fine particles: powder particle size 20-45 μm.

3.3 Placement

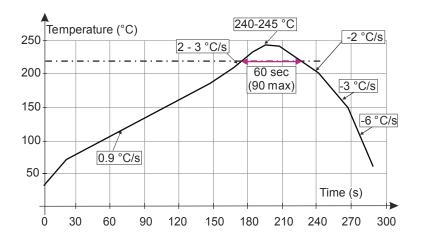
- 1. Manual positioning is not recommended.
- 2. It is recommended to use the lead recognition capabilities of the placement system, not the outline centering
- 3. Standard tolerance of ±0.05 mm is recommended.
- 4. 3.5 N placement force is recommended. Too much placement force can lead to squeezed out solder paste and cause solder joints to short. Too low placement force can lead to insufficient contact between package and solder paste that could cause open solder joints or badly centered packages.
- 5. To improve the package placement accuracy, a bottom side optical control should be performed with a high resolution tool.
- 6. For assembly, a perfect supporting of the PCB (all the more on flexible PCB) is recommended during solder paste printing, pick and place and reflow soldering by using optimized tools.

3.4 PCB design preference

- 1. To control the solder paste amount, the closed via is recommended instead of open vias.
- 2. The position of tracks and open vias in the solder area should be well balanced. A symmetrical layout is recommended, to avoid any tilt phenomena caused by asymmetrical solder paste due to solder flow away.

3.5 Reflow profile

Figure 15. ST ECOPACK[®] recommended soldering reflow profile for PCB mounting



Note: Minimize air convection currents in the reflow oven to avoid component movement.



4 Ordering information

Figure 16. Ordering information scheme

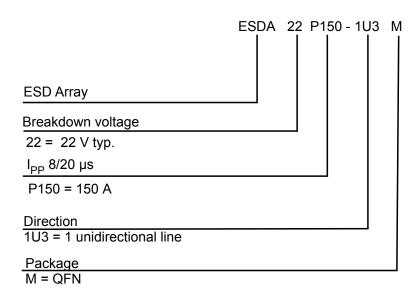


Table 5. Ordering information

Order code	Marking	Weight	Base qty.	Delivery mode
ESDA22P150-1U3M	22A	7 mg	5000	Tape and reel

1. The marking can be rotated by multiples of 90° to differentiate assembly location.

Revision history

Table 6. Document revision history

Date	Revision	Changes
24-May-2018	1	First issue.



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